

## NCE N-Channel Enhancement Mode Power MOSFET

### **Description**

The NCE6020Al uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

V<sub>DS</sub> =60V,I<sub>D</sub> =20A

 $R_{DS(ON)}$  <25m $\Omega$  @  $V_{GS}$ =10V

 $R_{DS(ON)}$  <31m $\Omega$  @  $V_{GS}$ =4.5V

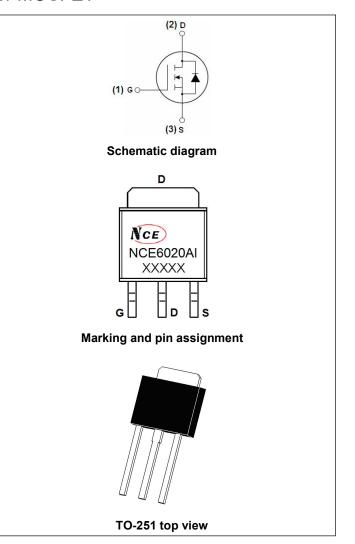
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

#### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6020AI	NCE6020AI	TO-251	-	-	-

#### Absolute Maximum Ratings (T<sub>c</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	60	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	20	А
Drain Current-Continuous(T <sub>C</sub> =100 ℃)	I <sub>D</sub> (100°C)	14	А
Pulsed Drain Current	I <sub>DM</sub>	60	А
Maximum Power Dissipation	P <sub>D</sub>	45	W
Derating factor		0.3	W/℃
Single pulse avalanche energy (Note 5)	Eas	72	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	°C



## **Thermal Characteristic**

Thermal Resistance,Junction-to-Case <sup>(Note 2)</sup>	R <sub>eJC</sub>	3.3	°C/W	
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#### **Electrical Characteristics (Tc=25**°Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•			
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	Igss	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics (Note 3)	·					
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA	1.2	1.6	2.5	V
Davis Course On Otata Basistana	Б	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	-	21	25	
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A		25.5	31	mΩ
Forward Transconductance	<b>G</b> FS	V <sub>DS</sub> =5V,I <sub>D</sub> =5A	11	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	\/ 00\/\\ 0\/	-	973.2	-	PF
Output Capacitance	Coss	V <sub>DS</sub> =30V,V <sub>GS</sub> =0V,	-	61.2	-	PF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1.0MHz	-	58.8	-	PF
Switching Characteristics (Note 4)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	5	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =30V, $I_D$ =2A, $R_L$ =6.7 $\Omega$	-	2.6	-	nS
Turn-Off Delay Time	$t_{d(off)}$	$V_{GS}$ =10V, $R_{G}$ =3 $\Omega$	-	16.1	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	2.3	-	nS
Total Gate Charge	Qg	V 00V/1 4.5A	-	25		nC
Gate-Source Charge	Qgs	V <sub>DS</sub> =30V,I <sub>D</sub> =4.5A,	-	4.5		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	6.5		nC
Drain-Source Diode Characteristics			'			
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =20A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	20	Α
Reverse Recovery Time	t <sub>rr</sub>	TJ = 25°C, IF =20A	-	29	-	nS
Reverse Recovery Charge	very Charge Qrr di/dt = 100A/µs <sup>(Note3)</sup>		-	49	-	nC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negli	gible (tur	n-on is do	ominated b	y LS+LD)

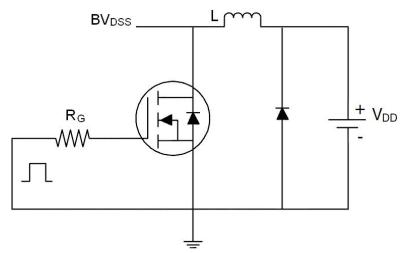
#### Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board,  $t \le 10$  sec.
- 3. Pulse Test: Pulse Width  $\leq$  300 $\mu$ s, Duty Cycle  $\leq$  2%.
- **4.** Guaranteed by design, not subject to production
- **5.** EAS condition:Tj=25 $^{\circ}$ C,VDD=30V,VG=10V,L=0.5mH,Rg=25 $\Omega$

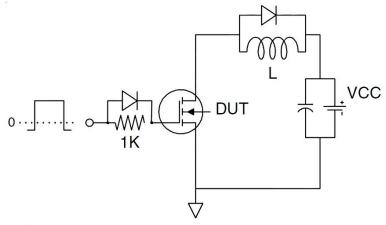


## **Test Circuit**

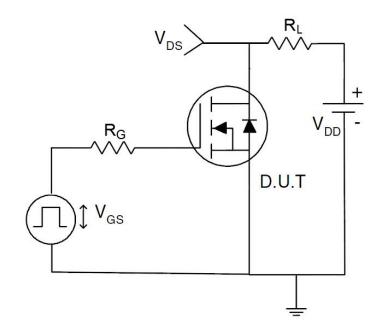
## 1) E<sub>AS</sub> test Circuit



## 2) Gate charge test Circuit

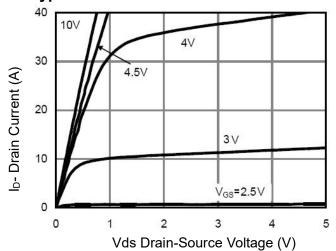


## 3) Switch Time Test Circuit

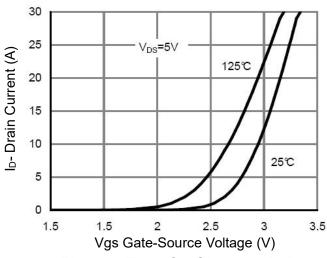




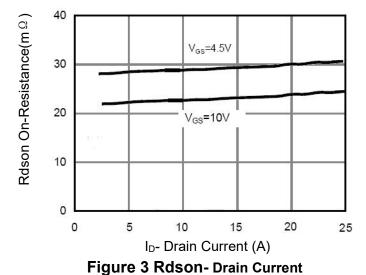
## Typical Electrical and Thermal Characteristics (Curves)

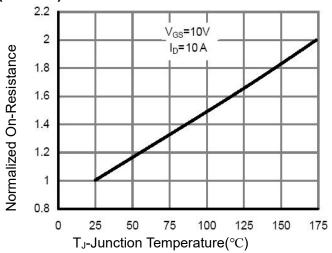


**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 





**Figure 4 Rdson-Junction Temperature** 

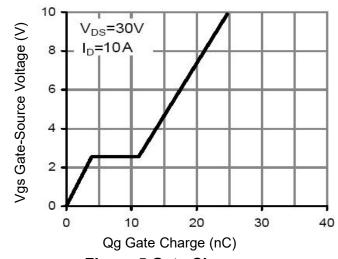


Figure 5 Gate Charge

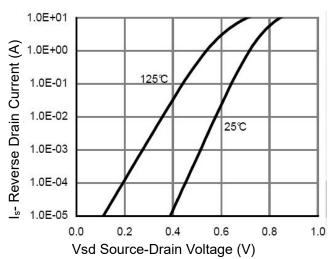


Figure 6 Source- Drain Diode Forward



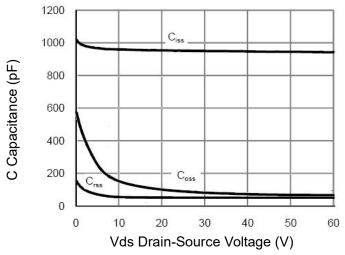


Figure 7 Capacitance vs Vds

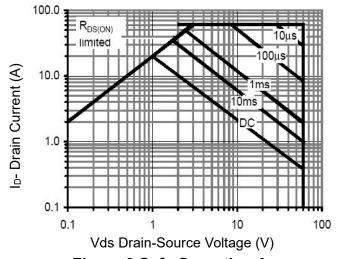


Figure 8 Safe Operation Area

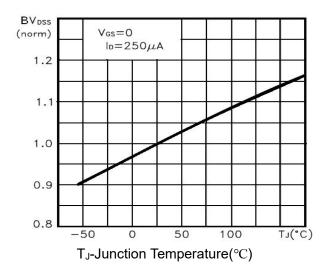


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

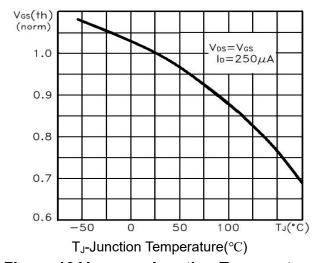
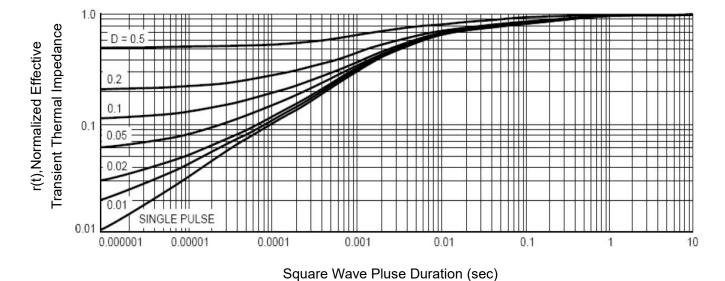


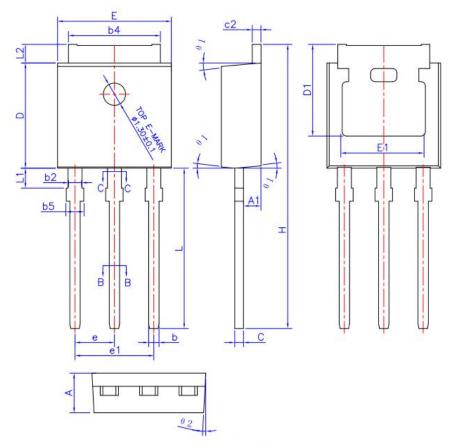
Figure 10 V<sub>GS(th)</sub> vs Junction Temperature



**Figure 11 Normalized Maximum Transient Thermal Impedance** 

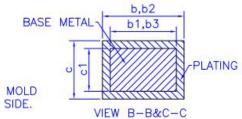


## **TO-251 Package Information**



# COMMON DIMENSIONS (UNITS OF MEASURE =MILLIMETER)

SYMBOL	MIN	NOM	MAX
Α	2.20	2.30	2.35
A1	0.90	1.01	1.10
b	0.56		0.69
b1	0.55	0.60	0.65
b2	0.77		0.90
b3	0.76	0.81	0.86
b4	5.23	5.33	5.43
b5			1.05
С	0.46		0.59
c1	0.45	0.51	0.55
c2	0.46		0.59
D	6.00	6.10	6.20
D1	5.20		-
E	6.50	6.60	6.70
E1	4.60	4.83	5.00
е	2.24	2.29	2.34
e1	4.47	4.57	4.67
Н	16.18	16.48	16.78
L	9.00	9.30	9.60
L1	0.95	1.16	1.35
L2	0.90	1.08	1.25
01	3°	5°	7°
02	1°	3°	5°



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